

## Econo Dual module with Trench/Fieldstop IGBT and Fast recovery diode and NTC

### Features

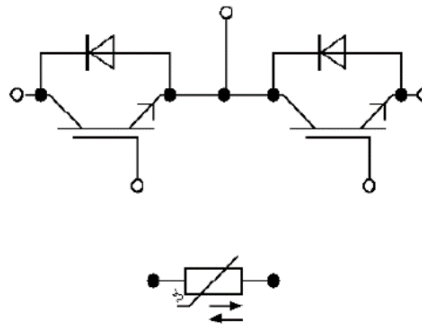
- Low Switching Losses
- Low  $V_{CEsat}$
- Low  $V_{CE(sat)}$  with Positive Temperature Coefficient

### Applications

- Motor/ Servo Drives
- High Power Converters
- UPS Systems



### Equivalent Circuit Schematic



### IGBT - Inverter

#### Maximum Rated Values

Symbol	Description	Conditions	Values	Unit
$V_{CES}$	Collector-Emitter Voltage	$T_{vj}=25^{\circ}C$	1200	V
$V_{GES}$	Gate-Emitter Peak Voltage	$T_{vj}=25^{\circ}C$	$\pm 20$	V
$I_C$	Continuous DC Collector Current	$T_C=100^{\circ}C$	450	A
$I_{CRM}$	Repetitive Peak Collector Current	$t_p=1ms$	900	A
$P_{tot}$	Total Power Dissipation	$T_C=25^{\circ}C, T_{vj\ max}=175^{\circ}C$	2265	W

**Characteristic Values**

Symbol	Description	Conditions	Values			Unit
			Min.	Typ.	Max.	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> =450A, T <sub>vj</sub> =25°C	---	1.65	--	V
		V <sub>GE</sub> =15V, I <sub>C</sub> =450A, T <sub>vj</sub> =125°C	---	1.85	--	V
V <sub>GE(th)</sub>	Gate Threshold Voltage	V <sub>GE</sub> =V <sub>CE</sub> , I <sub>C</sub> =17.1mA	5.0	5.6	6.8	V
I <sub>CES</sub>	Collector-Emitter Cut-Off Current	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V	---	---	1	mA
I <sub>GES</sub>	Gate-Emitter Leakage Current	V <sub>GE</sub> =20V, V <sub>CE</sub> =0V	---	---	600	nA
R <sub>Gint</sub>	Internal Gate Resistor	T <sub>vj</sub> =25°C	---	1.6	---	Ω
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> =25V, V <sub>GE</sub> =0V, f=1MHz	---	37	---	nF
C <sub>res</sub>	Reverse Transfer Capacitance		---	1.4	---	nF
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>CC</sub> =600V V <sub>GE</sub> =±15V I <sub>C</sub> =450A R <sub>G</sub> =0.36Ω Inductive Load T <sub>vj</sub> =25°C	---	160	---	ns
t <sub>r</sub>	Turn-on Rise Time		---	36	---	ns
t <sub>d(off)</sub>	Turn-off Delay Time		---	350	---	ns
t <sub>f</sub>	Turn-off Fall Time		---	150	---	ns
E <sub>on</sub>	Turn-on Switching Loss		---	7.8	---	mJ
E <sub>off</sub>	Turn-off Switching Loss		---	36	---	mJ
I <sub>SC</sub>	Short Circuit Data	V <sub>GE</sub> ≤15V, V <sub>CC</sub> =600V t <sub>p</sub> ≤10μs, T <sub>vj</sub> =25°C	---	1980	---	A
R <sub>thJC</sub>	Thermal Resistance, Junction to Case	Per IGBT	---	---	0.059	K/W
T <sub>VJ OP</sub>	Virtual Junction Temperature	Under Switching	-40	---	150	°C

**NTC-Thermistor  
Characteristic Values**

Symbol	Description	Conditions	Values			Unit
			Min.	Typ.	Max.	
R <sub>25</sub>	Rated Resistance	T <sub>C</sub> =25°C	---	5	---	KΩ
P <sub>25</sub>	Power Dissipation	T <sub>C</sub> =25°C	---	20	---	mW
B <sub>25/50</sub>	B Value	R <sub>2</sub> = R <sub>25</sub> exp [B <sub>25/50</sub> (1/T <sub>2</sub> - 1/(298 K))]	---	3375	---	K

**Diode - Inverter  
Maximum Rated Values**

Symbol	Description	Conditions	Values	Unit
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	T <sub>vj</sub> =25°C	1200	V
I <sub>F</sub>	Continuous DC Forward Current		450	A
I <sub>FRM</sub>	Repetitive Peak Collector Current	t <sub>p</sub> =1ms	900	A

## Characteristic Values

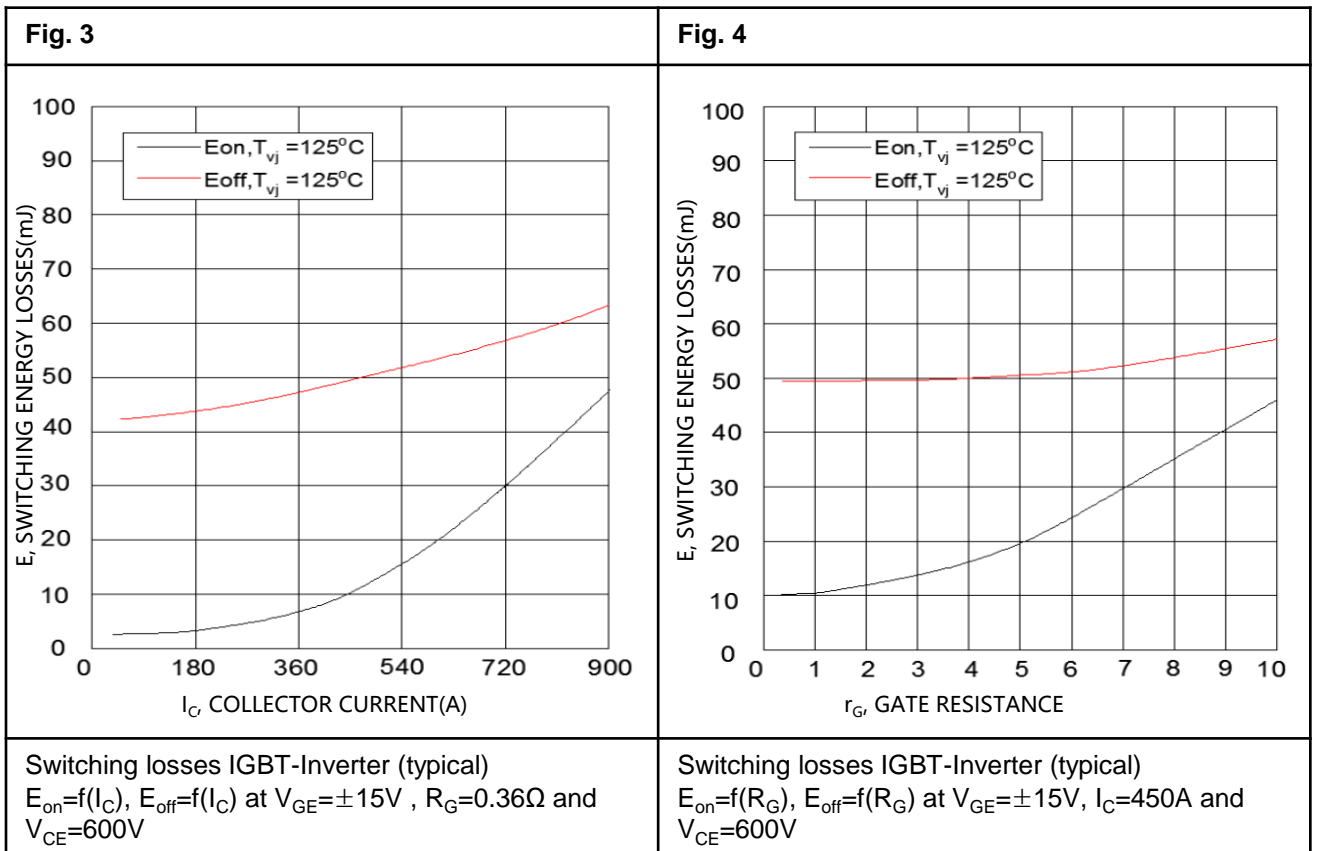
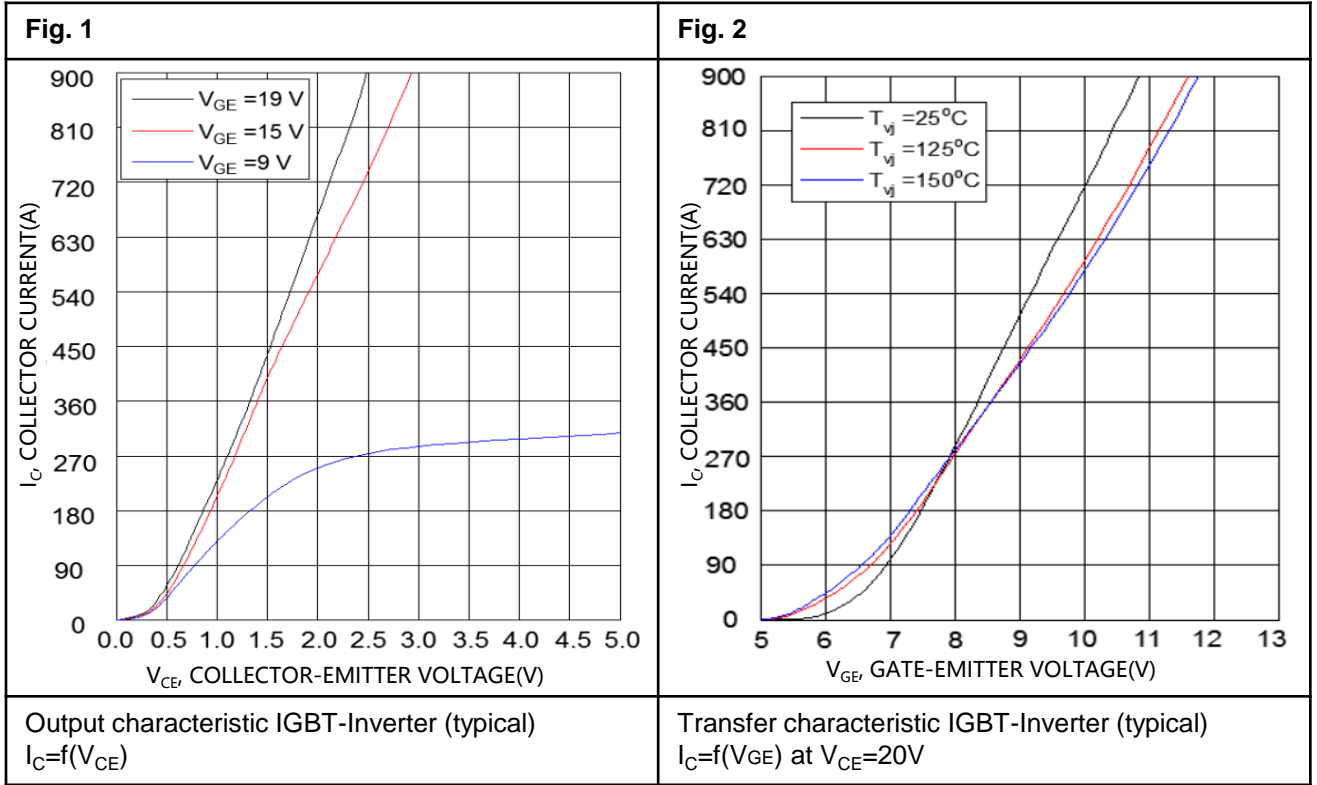
Symbol	Description	Conditions	Values			Unit
			Min.	Typ.	Max.	
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =450A, V <sub>GE</sub> =0V, T <sub>vj</sub> =25°C	---	2.0	---	V
		I <sub>F</sub> =450A, V <sub>GE</sub> =0V, T <sub>vj</sub> =125°C	---	1.7	---	V
I <sub>RM</sub>	Peak Reverse Recovery Current	I <sub>F</sub> =450A, V <sub>R</sub> =600V, V <sub>GE</sub> =-15V T <sub>vj</sub> =25°C	---	450	---	A
Q <sub>r</sub>	Recovered Charge		---	52	---	uC
E <sub>rec</sub>	Reverse Recovery Energy		---	25.8	---	mJ
T <sub>vj OP</sub>	Virtual Junction Temperature	Under Switching	-40	---	150	°C

## Module

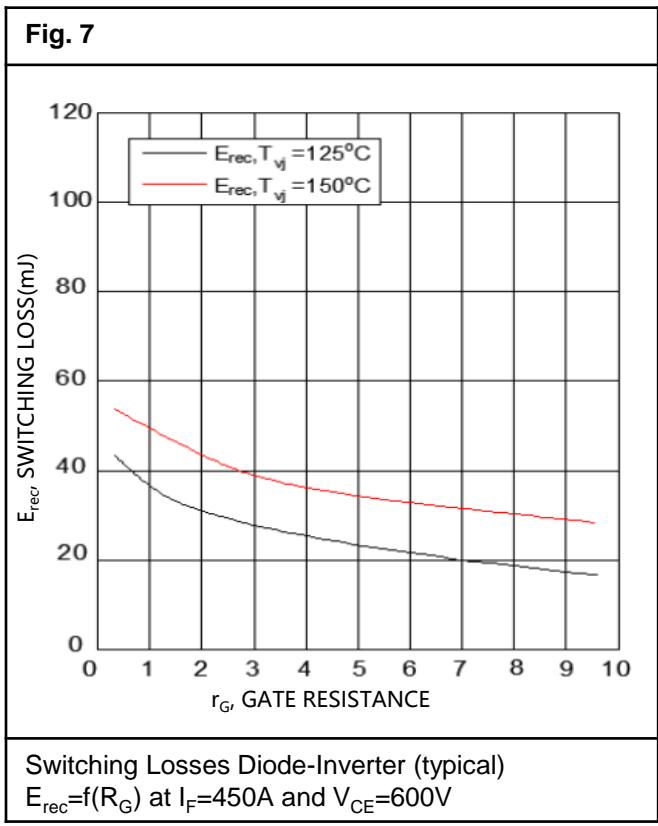
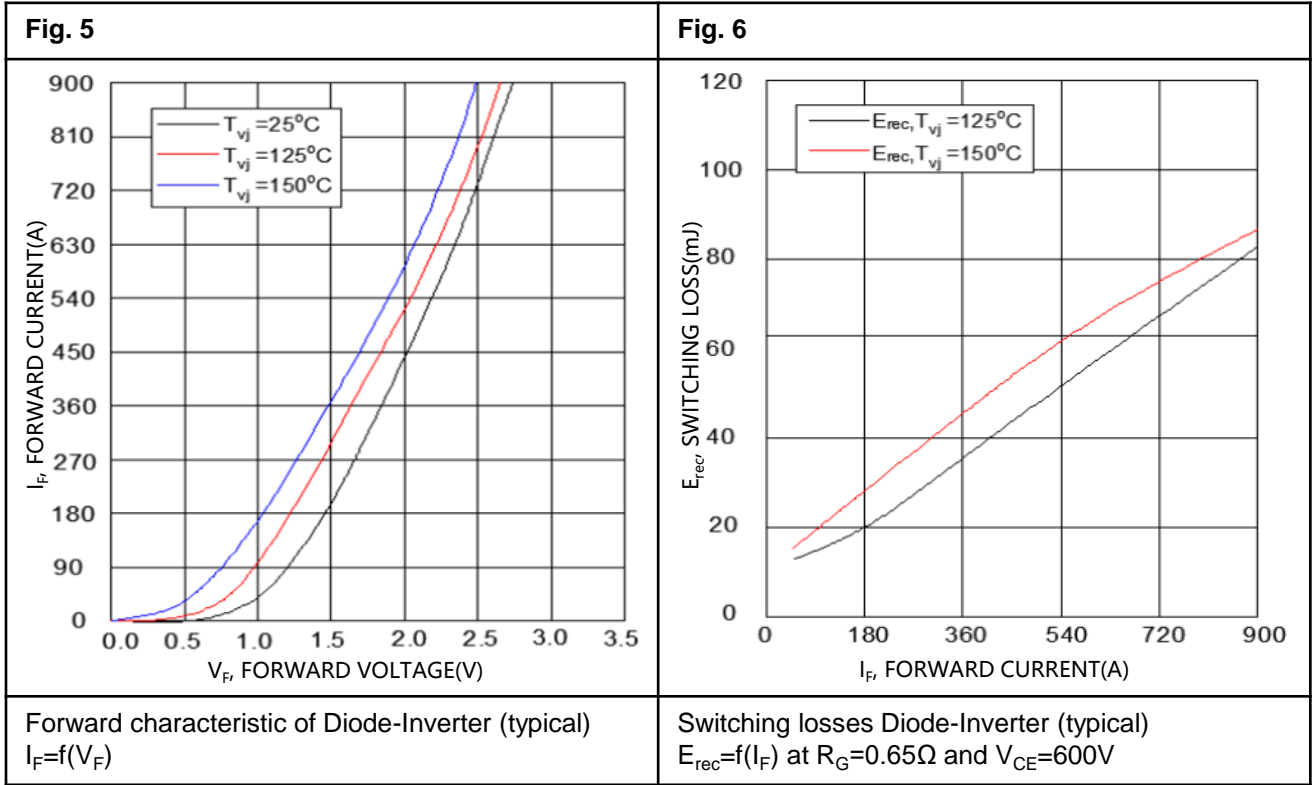
Symbol	Description	Conditions	Values	Unit
V <sub>ISOL</sub>	Isolation Test Voltage	RMS, f=50Hz, t=1min	4	KV
	Material of Module Baseplate		Cu	
	Internal Isolation	Basic Insulation (Class 1, IEC 61140)	Al <sub>2</sub> O <sub>3</sub>	
	Creepage Distance	Terminal to Heatsink	14.5	mm
		Terminal to Terminal	13.0	
	Clearance	Terminal to Heatsink	13.0	mm
		Terminal to Terminal	10.5	
CTI	Comparative Tracking Index		> 200	

Symbol	Description	Conditions	Values			Unit
			Min.	Typ.	Max.	
R <sub>thCH</sub>	Thermal Resistance, Case to Heatsink	Per Module λ <sub>Paste</sub> =1W/(m·k) / λ <sub>Grease</sub> =1W/(m·k)	---	0.009	---	K/W
L <sub>sCE</sub>	Stray Inductance Module		---	20	---	nH
R <sub>CC'+EE'</sub>	Module Lead Resistance, Terminals-chip	TC=25°C, Per Switch	---	0.99	---	mΩ
T <sub>stg</sub>	Storage Temperature		-40	---	125	°C
M	Mounting Torque for Modul Mounting		3.0	---	6.0	Nm
G	Weight		---	350	---	g

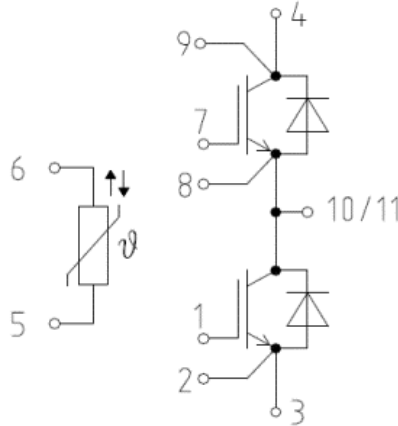
# Typical Characteristics



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## Circuit Diagram



## Package Outlines (mm)

